## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT6162973

| SUBMISSION TYPE:      | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT     |

#### **CONVEYING PARTY DATA**

| Name              | Execution Date |
|-------------------|----------------|
| SHINGO NASU       | 03/23/2020     |
| SHINJI SETO       | 03/26/2020     |
| NOBUYUKI ICHIMARU | 03/23/2020     |
| RYUSUKE HIRAO     | 03/27/2020     |

#### **RECEIVING PARTY DATA**

| Name:           | HITACHI AUTOMOTIVE SYSTEMS, LTD. |
|-----------------|----------------------------------|
| Street Address: | 2520, TAKABA                     |
| City:           | HITACHINAKA-SHI, IBARAKI         |
| State/Country:  | JAPAN                            |

#### **PROPERTY NUMBERS Total: 1**

| Property Type       | Number   |
|---------------------|----------|
| Application Number: | 16956356 |

#### CORRESPONDENCE DATA

Fax Number: (202)672-5399

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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**FOLEY & LARDNER LLP Correspondent Name:** Address Line 1: 3000 K STREET N.W.

Address Line 2: SUITE 600

Address Line 4: WASHINGTON, D.C. 20007-5109

| ATTORNEY DOCKET NUMBER: | 091715-0281   |
|-------------------------|---------------|
| NAME OF SUBMITTER:      | NAOMI GREEN   |
| SIGNATURE:              | /Naomi Green/ |
| DATE SIGNED:            | 06/19/2020    |

#### **Total Attachments: 4**

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> **PATENT** REEL: 052992 FRAME: 0192

506116249

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PATENT REEL: 052992 FRAME: 0193

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI AUTOMOTIVE SYSTEMS, LTD., a corporation organized under the laws of Japan, located at 2520, Takaba, Hitachinaka-shi, Ibaraki, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI AUTOMOTIVE SYSTEMS, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

# VEHICLE, VEHICLE MOTION STATE ESTIMATION APPARATUS, AND METHOD FOR ESTIMATING VEHICLE MOTION STATE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI AUTOMOTIVE SYSTEMS, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI AUTOMOTIVE SYSTEMS, LTD.

Signed on the date(s) indicated aside our signatures:

|             | INVENTOR(S)<br>(発明者フルネームサイン) |             | Date Signed<br>(署名日) |
|-------------|------------------------------|-------------|----------------------|
| 1) Shingo   | Nasu Shingo Nasei            |             | 3/23/2020            |
| 2) Shinji S | Ü                            |             |                      |
|             |                              |             | ,                    |
| 3) Nobuyu   | Ki ichimaru                  |             |                      |
| 4) Ryusuke  | e Hirao ,                    |             |                      |
| 5)          |                              | <del></del> |                      |
| 6)          |                              |             |                      |
| 7)          |                              |             |                      |
| 8)          | ·                            |             |                      |
|             |                              | <del></del> |                      |
| 9)          |                              |             |                      |
| 10)         |                              |             |                      |

PATENT REEL: 052992 FRAME: 0194

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Signed on the date(s) indicated aside our signatures:

INVENTOR(S)

> PATENT REEL: 052992 FRAME: 0195

Date Signed

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INVENTOR(S)

|                    | (発明者フルネームサイン)      |  | (署名日)     |
|--------------------|--------------------|--|-----------|
| 1) Shingo Nasu     |                    | 4 1 <del>4</del>                         |           |
| 2) Shinji Seto     | 4                  |  |           |
| 3) Nobuyuki Ichima | n Nobujuki Lhimoru |  | 3/23/2020 |
| 4) Ryusuke Hirao   | 8                  | • <u></u>                                |           |
| 5)                 |                    | es e |           |
| 6)                 |                    | **************************************   |           |
| 7)                 |                    |  |           |
| 8)                 | *                  | :8                                       | 8 8888    |
| 9)                 |                    | 3 Same                                   |           |
| 10)                |                    |  | *         |

PATENT REEL: 052992 FRAME: 0196

Date Signed

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INVENTOR(S)

|                  | (発明者プルネームサイン) | (署名日)     |
|------------------|---------------|-----------|
| 1) Shingo Nasu   |               |           |
| 2) Shinji Seto   |               |           |
| Nobuyuki Ichima  | nī.           |           |
| 4) Ryusuke Hirao | Ryusuke Hirao | 3/21/2020 |
| 5)               |               |           |
| 6)               | 8             |           |
| 7)               |               |           |
| 8)               |               |           |
| 9)               |               |           |
| 10)              |               |           |

PATENT REEL: 052992 FRAME: 0197

**Date Signed** 

**RECORDED: 06/19/2020**